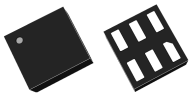
LD39130S

Datasheet

300 mA very low quiescent current linear regulator IC with automatic green mode

Flip-chip 4



DFN6 1.2x1.3

Maturity status link
LD39130S

Features

- Input voltage from 1.4 to 5.5 V
- Ultra low dropout voltage (300 mV typ. at 300 mA load)
- Automatic green mode
- Very low quiescent current (1 µA in green mode, 45 µA in normal mode and 0.1 µA typ. in off mode)
- Output voltage tolerance: ±1.0% at 25 °C
- 300 mA guaranteed output current
- Wide range of output voltages available on request: adjustable from 0.8 V, fixed up to 4.0 V in 100 mV step
- Logic-controlled electronic shutdown
- Internal soft-start
- Compatible with ceramic capacitor C_{OUT} = 330 nF
- Internal current foldback and thermal protections
- Available in DFN6 1.2x1.3 mm and Flip-chip 4 bumps 0.69 x 0.69 mm. 0.4 pitch
- Operating temperature range: -40 °C to 125 °C
- Available in 5 k or 10 k bulk depending on output voltage

Applications

- Mobile phones
- Digital still cameras (DSC)
- Cordless phones and similar battery-powered systems
- Portable media players

Description

The LD39130S is a high accuracy voltage regulator that provides 300 mA maximum current from an input voltage ranging from 1.4 V to 5.5 V, with a typical dropout voltage of 300 mV.

It is available in DFN6 1.2 x 1.3 mm package and in ultra-small Flip-chip 4 bumps package, allowing the maximum space saving.

The device is stabilized with a ceramic capacitor on the output. The ultra-low drop voltage, low quiescent current and low noise features make it suitable for low power battery-operated applications. It integrates an internal logic circuitry, which allows the regulator to be in ultra-low consumption mode (green mode), when the output current required is very low. The normal working mode, with fast transient response, is restored when the load current increases.

The enable logic control function puts the LD39130S in shutdown mode allowing a total current consumption lower than 0.1 µA. The current foldback and thermal protection are provided.

1 Block diagrams

Figure 1. **Block diagram (adjustable version)**

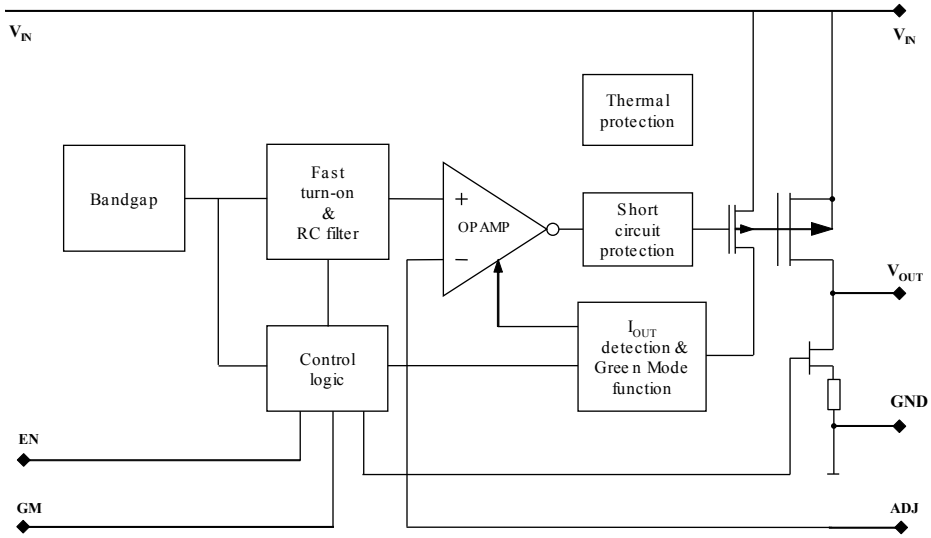
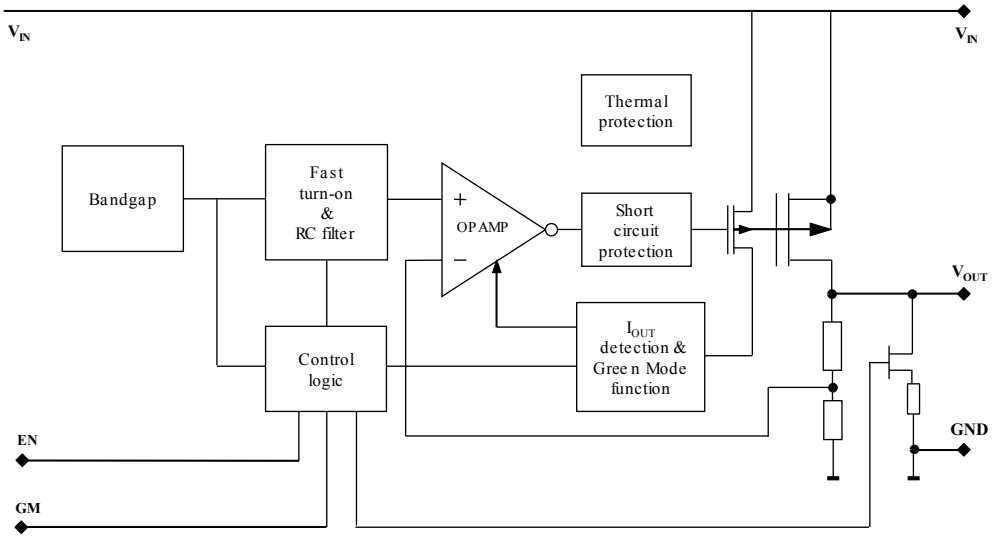
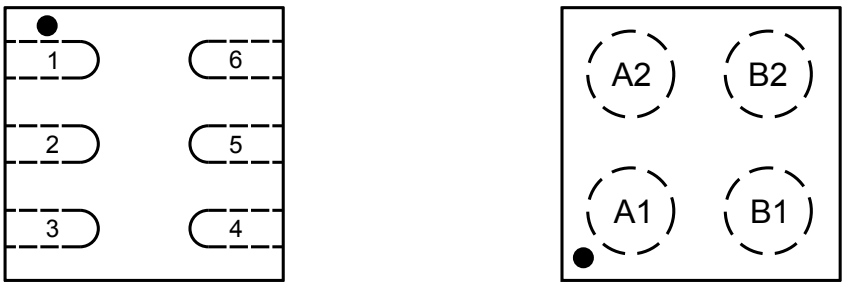


Figure 2. **Block diagram (fixed version)**



2 Pin configuration

Figure 3. **Pin connection (top view)**



DFN6 Flip chip 4

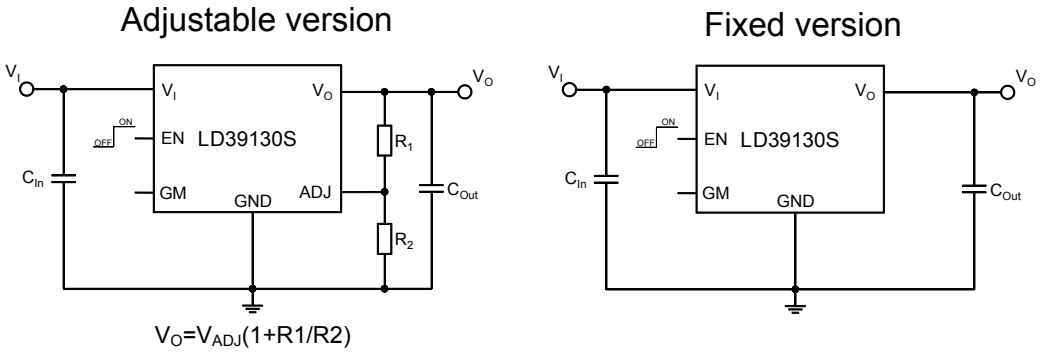
Table 1. **Pin description**

Pin n°		Symbol	Function
DFN6	Flip chip		
1		GM	Auto green mode selection: low = active, high = disabled. This pin is internally pulled-down to GND.
2	B2	GND	Common ground
3	B1	EN	Enable pin logic input: low = shutdown, high = active. This pin is internally pulled-down to GND.
4	A1	IN	Input voltage
5		ADJ/NC (1)	Adjust pin
6	A2	OUT	Output voltage

1. *Not connected in the fixed output voltage version.*

3 Typical applications

Figure 4. Typical application circuits



Note: GM and ADJ pins are available on the DFN6 package only.

4 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	DC input voltage	-0.3 to 7	V
V_{OUT}	DC output voltage	-0.3 to V_I +0.3	V
V_{EN}	Enable input voltage	-0.3 to V_I +0.3	V
V_{GM}	Auto green mode input voltage	-0.3 to V_I +0.3	V
V_{ADJ}	Adjust pin voltage	-0.3 to 2	V
I_{OUT}	Output current	Internally limited	mA
P_D	Power dissipation	Internally limited	mW
T_{STG}	Storage temperature range	-65 to 150	°C
T_{OP}	Operating junction temperature range	-40 to 125	°C

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. All values are referred to GND.

Table 3. Thermal data

Symbol	Parameter	Value		Unit
		DFN6	Flip chip 4	
R_{thJA}	Thermal resistance junction-ambient	237	130	°C/W
R_{thJC}	Thermal resistance junction-case	104		°C/W

Table 4. ESD performance

Symbol	Parameter	Test conditions	Value	Unit
ESD	ESD protection voltage	HBM	2	kV
		CDM(DFN version)	200	V
		CDM(CSP version)	300	V

5 Electrical characteristics

T_J = 25 °C, V_{IN} = $V_{OUT(NOM)}$ + 1 V, C_{IN} = C_{OUT} = 1 µF, I_{OUT} = 1 mA, V_{EN} = V_{IN}, unless otherwise specified.

Table 5. LD39130S/LD39130SJ electrical characteristics (fixed versions)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{IN}	Operating input voltage		1.4		5.5	V
V_{OUT}	V_{OUT} accuracy (normal mode)	V_{OUT} > 2 V, I_{OUT} = 10 mA, T_J = 25 °C	-1.0		1.0	%
		V_{OUT} > 2 V, I_{OUT} = 10 mA, -40 °C < T_J < 125 °C	-2		2	%
		V_{OUT} ≤ 2 V, I_{OUT} = 10 mA, T_J = 25 °C	-20		20	mV
		V_{OUT} ≤ 2 V, I_{OUT} = 10 mA, -40 °C < T_J < 125 °C	-30		30	mV
	V_{OUT} accuracy (green mode)	V_{OUT} > 2 V, I_{OUT} = 1 mA, T_J = 25 °C	-1.0		1.0	%
		V_{OUT} > 2 V, I_{OUT} = 1 mA,-40 °C < T_J < 125 °C	-2		2	%
		V_{OUT} ≤ 2 V, I_{OUT} = 1 mA, T_J = 25 °C	-20		20	mV
		V_{OUT} ≤ 2 V, I_{OUT} = 1 mA, -40 °C < T_J < 125 °C	-30		30	mV
ΔV_{OUT}	Static line regulation (normal mode)	V_{OUT} + 0.5V ≤ V_{IN} ≤ 5.5 V, I_{OUT} = 10 mA V_{IN} > 1.4 V		0.02	0.20	%/V
	Static line regulation (green mode)	V_{OUT} + 0.5 V ≤ V_{IN} ≤ 5.5 V, I_{OUT} = 1 mA V_{IN} > 1.4 V			0.50	%/V
ΔV_{OUT}	Static load regulation	V_{OUT} > 2 V, I_{OUT} = 1 mA to 12 mA	-1.5		1.5	%
		12 mA to 300 mA (normal mode)		0.004		%/mA
V_{DROP}	Dropout voltage (1)	I_{OUT} = 300 mA, V_{OUT} > 2 V, -40 °C < T_J < 125 °C		300		mV
e_N	Output noise voltage	10 Hz to 100 kHz, I_{OUT} = 1 mA		100		μV_{RMS}/ V_{OUT}
		10 Hz to 100 kHz, I_{OUT} = 15 mA		38		
SVR	Supply voltage rejection V_{OUT} = 1.5 V (normal mode)	V_{IN} = V_{OUTNOM} + 1 V ±V_{RIPPLE}, V_{RIPPLE} = 0.1 V, freq. = 1 kHz, I_{OUT} = 30 mA		70		dB
		V_{IN} = V_{OUTNOM} + 0.5 V ±V_{RIPPLE}, V_{RIPPLE} = 0.1 V, freq. = 10 kHz, I_{OUT} = 30 mA		65		
I_Q	Quiescent current (normal mode)	I_{OUT} = 10 mA		45		µA
	Quiescent current (Green mode)	I_{OUT} = 0 mA		1	4	µA
$I_{Standby}$	Standby current	V_{IN} input current in off mode: V_{EN} = GND		0.1	1	µA
I_{SC}	Short-circuit current	R_L = 0 (current foldback protection)		50		mA
I_{OUT}	Output current		300			mA
V_{EN}	Enable input logic low	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J <1 25 °C			0.4	V
	Enable input logic high	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C	1			
I_{EN}	Enable pin input current	V_{SHDN} = V_{IN}			100	nA
I_{GH}	Normal mode switch threshold	Change from light load to normal load V_{GM} = GND (2)			10	mA
I_{GL}	Green mode switch threshold	Change from normal load to light load V_{GM} = GND	1	2		mA

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
		(2)				
V_{GM} (2)	Green mode input logic low	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C			0.4	V
	Green mode input logic high	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C	1			
I_{GM} (2)	Green mode pin current				100	nA
T_{ON} (3)	Turn-on time			100		µs
R_{ON}	Output voltage discharge path resistance	V_{EN} = GND		100		Ω
T_{SHDN}	Thermal shutdown			160		°C
	Hysteresis			20		
C_{OUT}	Output capacitor	Capacitance (see Section 7: Typical characteristics)	0.33		22	µF

1. *Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value.*
2. *On DFN6 package version only.*
3. *Turn-on time is time measured between the enable input just exceeding VEN high value and the output voltage just reaching 95% of its nominal value.*

T_J = 25 °C, V_{IN} = $V_{OUT(NOM)}$ + 1 V, C_{IN} = C_{OUT} = 1 µF, I_{OUT} = 1 mA, V_{EN} = V_{IN}, unless otherwise specified.

Table 6. LD39130S electrical characteristics (adjustable version)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{IN}	Operating input voltage		1.4		5.5	V
V_{ADJ}	V_{ADJ} accuracy (fixed normal mode)	I_{OUT} = 5 mA, T_J = 25 °C	780	800	820	mV
		I_{OUT} = 5 mA, V_{GM} = V_{IN}, -40 °C < T_J < 125 °C	770	800	830	mV
ΔV_{OUT}	Static line regulation (normal mode)	V_{OUT} + 0.5 V ≤ V_{IN} ≤ 5.5 V, I_{OUT} = 10 mA, V_{IN} > 1.4 V		0.02	0.20	%/V
	Static line regulation (green mode)	V_{OUT} + 0.5V ≤ V_{IN} ≤ 5.5 V, I_{OUT} = 1 mA, V_{IN} > 1.4 V			0.20	%/V
ΔV_{OUT}	Static load regulation	V_{OUT} > 2 V, I_{OUT} = 1 mA to 12 mA	-1.5		1.5	%
		10 mA to 300 mA (normal mode)		0.004		%/mA
V_{DROP}	Dropout voltage (1)	I_{OUT} = 300 mA, V_{OUT} > 2 V, -40 °C < T_J < 125 °C		300		mV
e_N	Output noise voltage	10 Hz to 100 kHz, I_{OUT} = 1 mA, V_{OUT} = V_{ADJ}		97		μV_{RMS}
		10 Hz to 100 kHz, I_{OUT} = 15 mA, V_{OUT} = V_{ADJ}		41		
SVR	Supply voltage rejection V_{OUT} = 1.5V (normal mode)	V_{IN} = V_{OUTNOM} + 1 V ± V_{RIPPLE}, V_{RIPPLE} = 0.1 V, freq. = 1 kHz, I_{OUT} = 30 mA		70		dB
		V_{IN} = V_{OUTNOM} + 0.5 V ± V_{RIPPLE}, V_{RIPPLE} = 0.1 V, Freq. = 10 kHz, I_{OUT} = 30 mA		65		
I_Q	Quiescent current (normal mode)	I_{OUT} = 10 mA		45		µA
	Quiescent current (Green mode)	I_{OUT} = 0 mA		0.8	4	µA
$I_{Standby}$	Standby current	V_{IN} input current in OFF MODE: V_{EN} = GND		0.1	1	µA
I_{SC}	Short-circuit current	R_L = 0 (current foldback protection)		50		mA
I_{OUT}	Output current		300			mA

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{EN}	Enable input logic low	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C			0.4	V
	Enable input logic high	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C	1			
I_{EN}	Enable pin input current	V_{SHDN} = V_{IN}			100	nA
I_{GH}	Normal mode switch threshold	Change from light load to normal load V_{GM} = GND			10	mA
I_{GL}	Green mode switch threshold	Change from normal load to light load V_{GM} = GND	1	2		mA
V_{GM}	Green mode input logic low	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C			0.4	V
	Green mode input logic high	V_{IN} = 1.4 V to 5.5 V, -40 °C < T_J < 125 °C	1			
I_{GM}	Green mode pin current				100	nA
T_{ON} (2)	Turn on time			100		µs
R_{ON}	Output voltage discharge path resistance	V_{EN} = GND		100		Ω
T_{SHDN}	Thermal shutdown			160		°C
	Hysteresis			20		
C_{OUT}	Output capacitor	Capacitance (see Section 7: Typical characteristics)	0.33		22	µF

1. *Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value.*
2. *Turn-on time is time measured between the enable input just exceeding VEN high value and the output voltage just reaching 95% of its nominal value*

6 Application information

6.1 Output voltage setting for ADJ version

In the adjustable version, the output voltage can be set from 0.8 V to the input voltage minus the voltage drop across the pass transistor (dropout voltage), by connecting a resistor divider between the ADJ pin and the output, allowing remote voltage sensing. The resistor divider can be determined using the following equation:

Equation 2

$$V_{OUT} = V_{ADJ} \times \left(1 + \frac{R1}{R2}\right) with\, V_{ADJ} = 0.8V\left(typ.\right) \quad (1)$$

Even if the regulator is stable with no load, the maximum value for R_2 should not exceed 2 MΩ in order to ensure the best dynamic performance.

6.2 Soft-start function

The LD39130S has an internal soft-start circuit. By increasing the startup time up to 100 µs, without the need of any external soft-start capacitor, this feature keeps the regulator inrush current at startup under control.

6.3 Auto green mode function

The LD39130S integrates an internal logic circuitry, which allows the regulator to be in ultra-low consumption mode (green mode), when the output current required is very low.

When the auto green mode is enabled, the regulator automatically selects its operating mode, switching from a very low consumption operation at light loads, to a very fast transient response mode when the load current increases.

In the LD39130S, in DFN6 package, this function can be disabled by the user, by means of an external logic pin (GM). When the GM pin is set at high logic level, the device always operates in normal mode (fast transient response), while if the GM pin is set low, the auto green mode is enabled.

The LD39130SJ (CSP version) always operates in auto green mode.

6.4 Input and output capacitors

The LD39130S requires external capacitors to ensure the regulator control loop stability. These capacitors must be selected to meet the requirements of minimum capacitance and equivalent series resistance (see Figure 32. Stability plan vs. (COUT, ESR)). Locating the input/output capacitors as close as possible to the relative pins, is suggested.

6.4.1 Input capacitor

A capacitor with a minimum value of 1 µF is required at the input voltage of the LD39130S. This capacitor must be located as close as possible to the input pin of the device and returned to a clean analog ground. Any good quality ceramic capacitor can be used.

6.4.2 Output capacitor

The control loop of the LD39130S is designed to work with ceramic capacitors at the output.

The output capacitor must meet the requirements for the minimum amount of capacitance and E.S.R. (equivalent series resistance) as shown in Figure 32. Stability plan vs. (COUT, ESR) .

The suggested value of 1 µF is a good choice to guarantee the stability of the regulator and to provide the optimum transient response. The output capacitor must maintain its ESR and capacitance in the stable region, over the full operating temperature range, to assure stability.

6.5 Output discharge function

The LD39130S integrates a MOSFET connected between V_{OUT} and GND. This transistor is activated when the EN pin goes to low logic level and has the function to quickly discharge the output capacitor when the device is disabled by the user.

7 Typical characteristics

(C_{IN} = C_{OUT} = 1 µF, V_{EN} = V_{IN} = 1.8 V, V_{OUT} = V_{ADJ}, T_j = 25 °C unless otherwise specified)

Figure 5. Output voltage vs. temperature (V_{IN} = 1.8 V, I_{OUT} = 5 mA, normal mode)

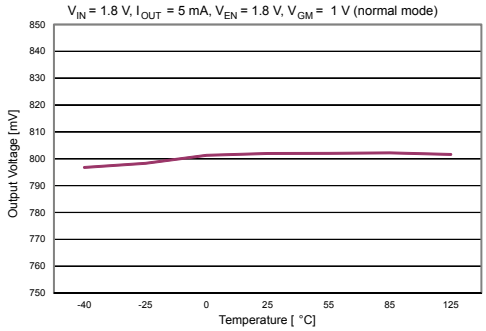


Figure 6. Output voltage vs. temperature (V_{IN} = 1.8 V, I_{OUT} = 300 mA, normal mode)

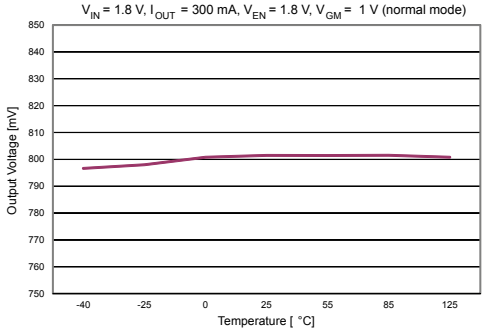


Figure 7. Output voltage vs. temperature (V_{IN} = 1.4 V, I_{OUT} = 1 mA, auto green mode)

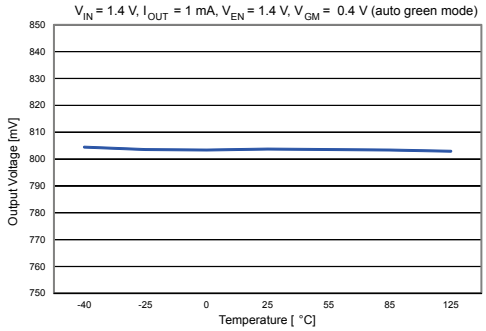


Figure 8. Output voltage vs. temperature (V_{IN} = 5.5 V, I_{OUT} = 1 mA, auto green mode)

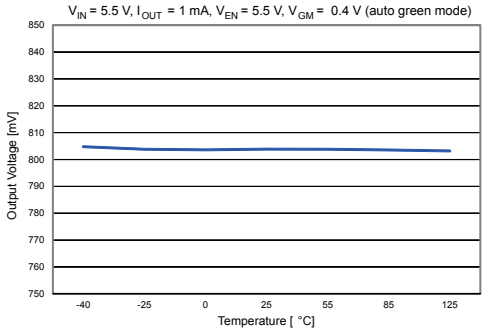


Figure 9. Line regulation vs. temperature (normal mode)

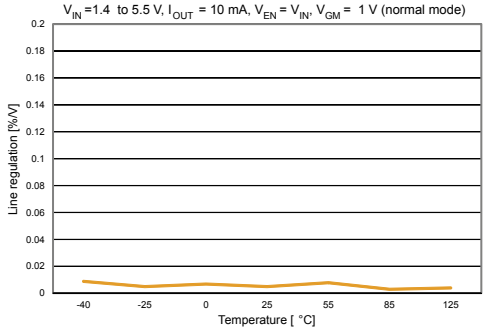


Figure 10. Line regulation vs. temperature (auto green mode)

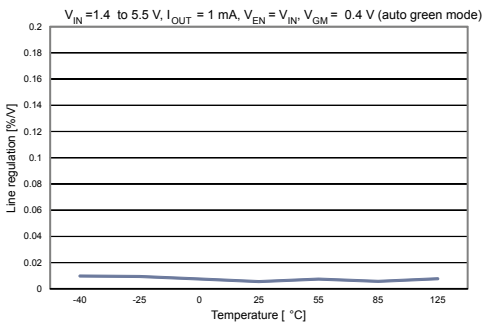


Figure 11. Load regulation vs. temperature (I_{OUT} = 1 to 10 mA, normal mode)

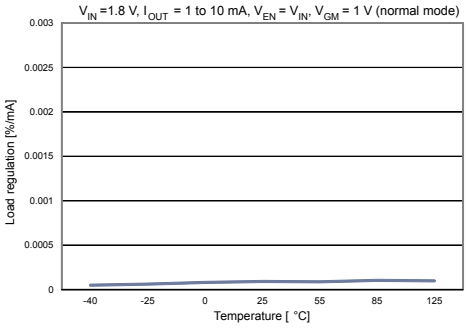


Figure 12. Load regulation vs. temperature (I_{OUT} = 10 to 300 mA, normal mode)

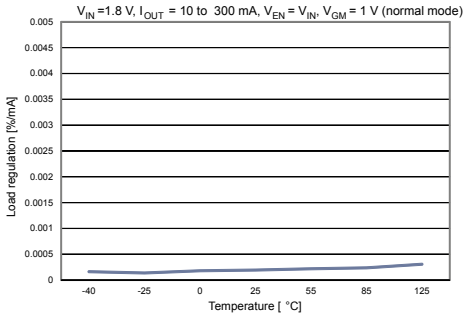


Figure 13. Load regulation vs. temperature (I_{OUT} = 1 to 12 mA, auto green mode)

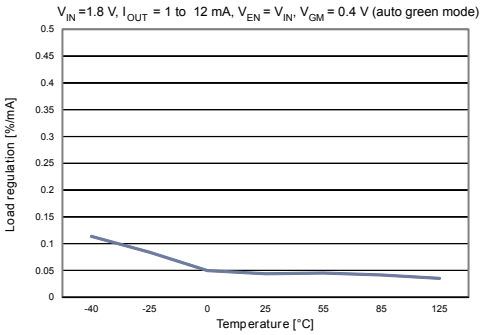


Figure 14. Mode change thresholds vs. temperature

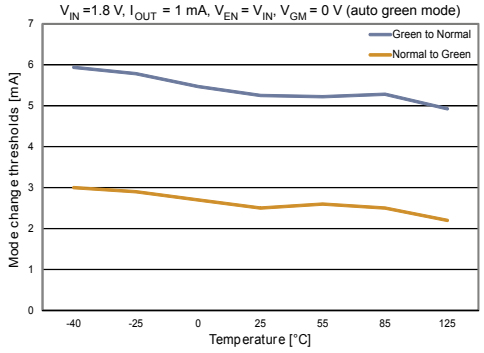


Figure 15. Quiescent current vs. temperature (I_{OUT} = 10 mA, normal mode)

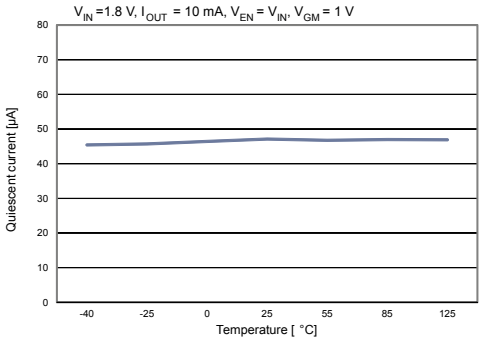


Figure 16. Quiescent current vs. temperature (I_{OUT} = 300 mA, normal mode)

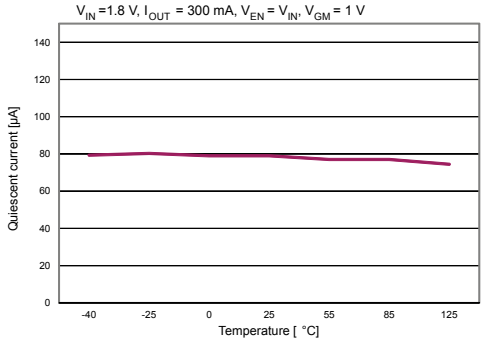


Figure 17. Quiescent current vs. temperature (no load, auto green mode)

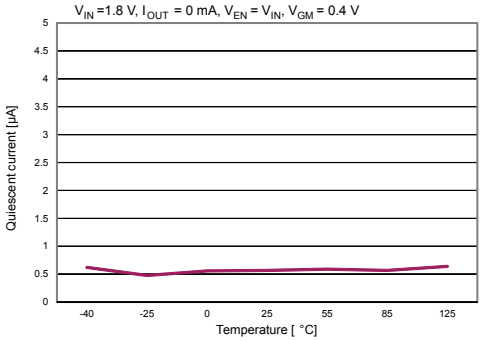


Figure 18. Shutdown current vs. temperature

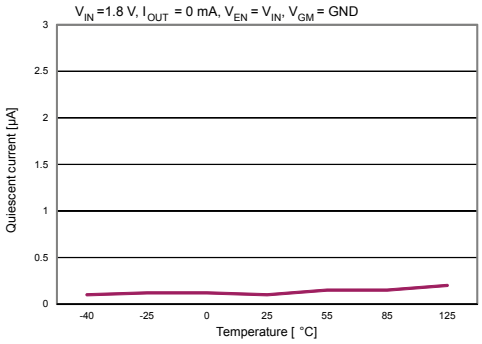


Figure 19. Quiescent current vs. input voltage (auto green mode)

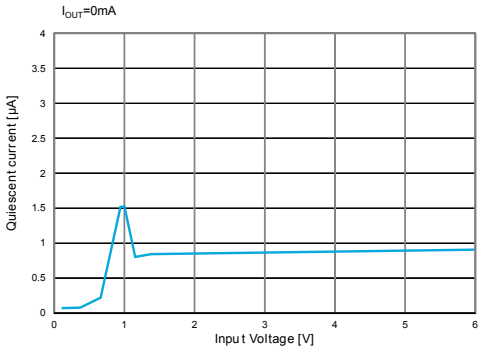


Figure 20. Quiescent current vs. input voltage (normal mode)

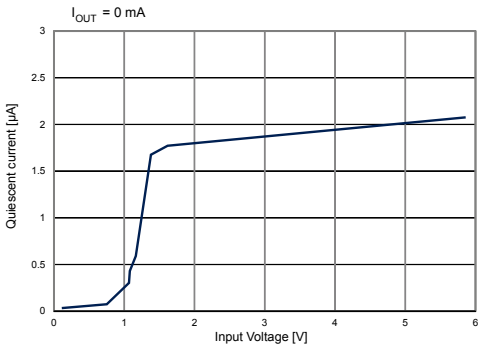


Figure 21. Quiescent current vs. output current (auto green mode)

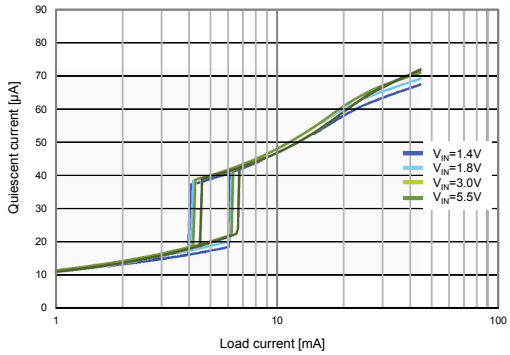


Figure 22. Quiescent current vs. load current (normal mode)

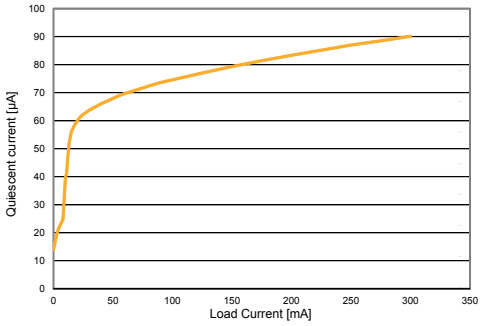


Figure 23. Quiescent current vs. load current (light load)

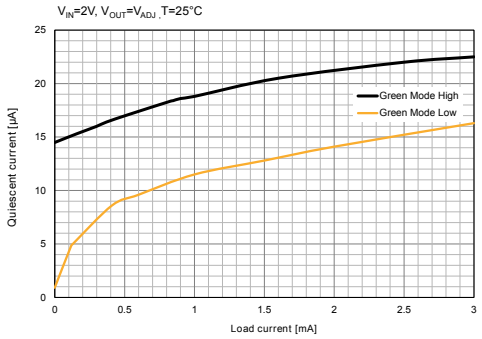


Figure 24. Short-circuit current vs. output voltage

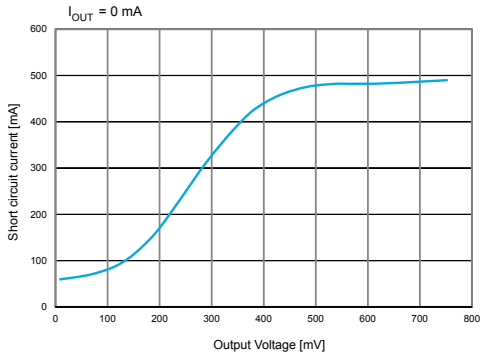


Figure 25. Foldback current vs. temperature

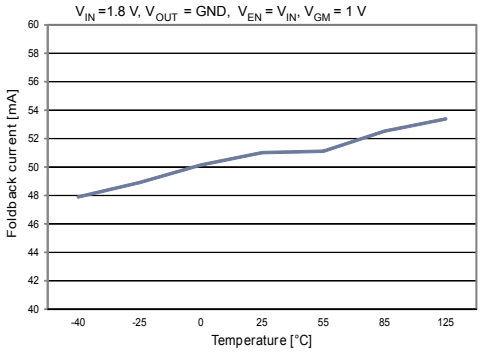


Figure 26. Dropout voltage vs. temperature

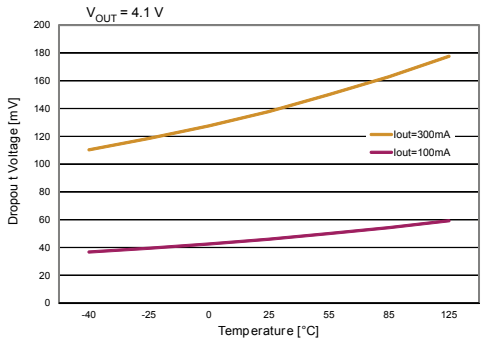


Figure 27. Dropout voltage vs. output current

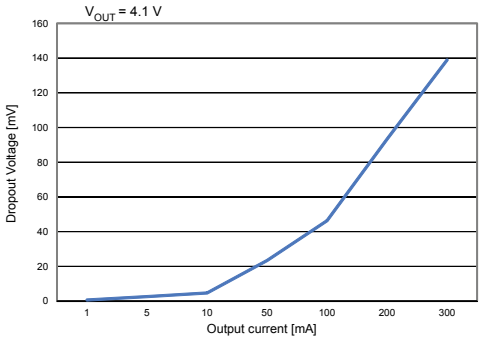


Figure 28. SVR vs. frequency (normal mode)

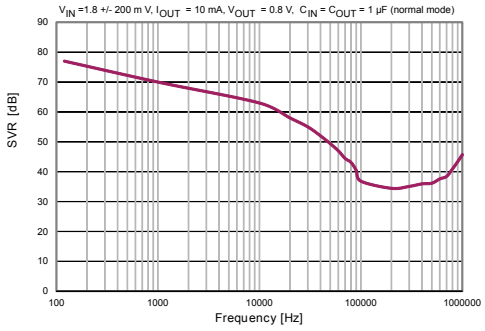


Figure 29. SVR vs. frequency (green mode)

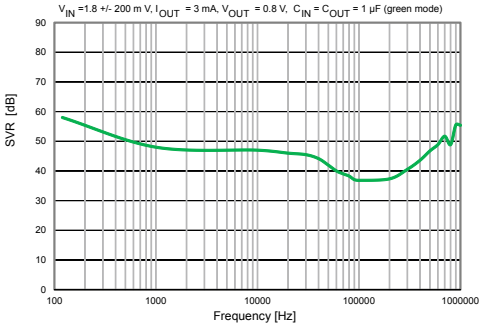


Figure 30. Noise spectrum vs. frequency ($V_{OUT} = V_{ADJ}$)

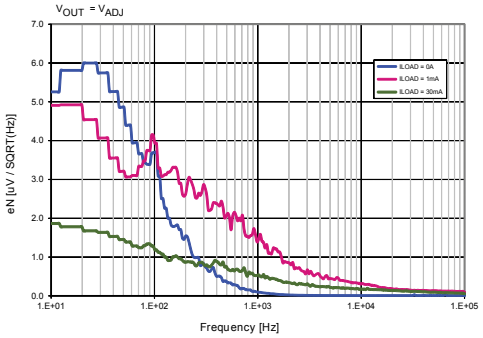


Figure 31. Noise spectrum vs. frequency (V_{OUT} = 4.1 V)

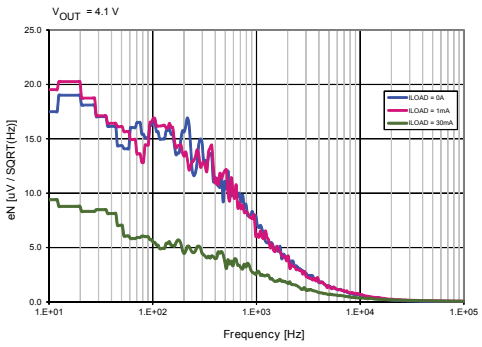


Figure 32. Stability plan vs. (COUT, ESR)

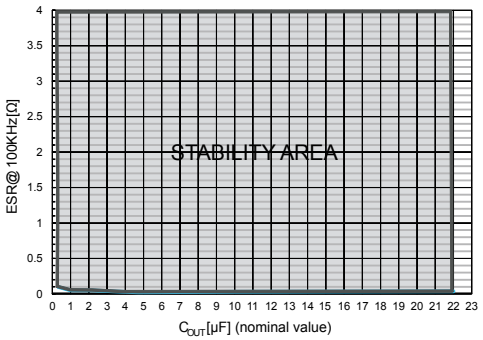


Figure 33. Startup by enable (I_{OUT} = 0 mA, auto green mode)

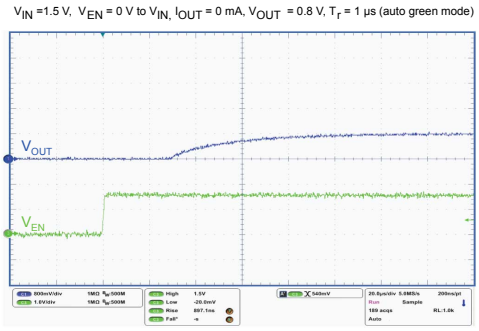


Figure 34. Turn-off by enable (I_{OUT} = 0 mA, auto green mode)

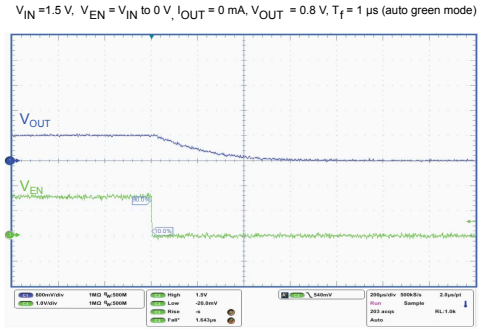


Figure 35. Startup by enable

V_{IN} =1.5 V, V_{EN} = 0V to V_{IN}, I_{OUT} = 300 mA, V_{OUT} = 0.8 V, T_r = 1 µs (auto green mode)

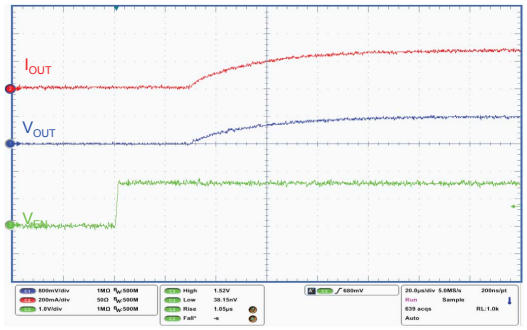


Figure 36. Turn-off by enable

V_{IN} = 1.5V, V_{EN} = V_{IN} to 0 V, I_{OUT} = 300 mA, V_{OUT} = 0.8 V, T_f = 1 µs, (auto green mode)

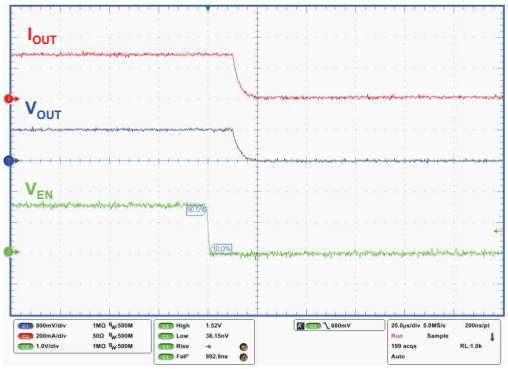


Figure 37. Startup by enable (I_{OUT} = 300 mA, normal mode)

V_{IN} =1.5 V, V_{EN} = 0 V to V_{IN}, V_{GM} = V_{IN}, I_{OUT} = 300 mA, V_{OUT} = 0.8 V, T_f = 1 µs (fixed normal mode)

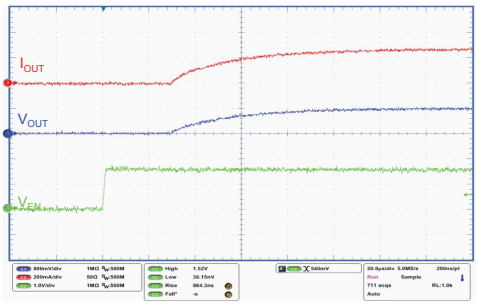


Figure 38. Turn-off by enable (I_{OUT} = 300 mA, normal mode)

V_{IN} =1.5 V, V_{EN} = V_{IN} to 0 V, V_{GM} = V_{IN}, I_{OUT} = 300 mA, V_{OUT} = 0.8 V, T_f = 1 µs (fixed normal mode)

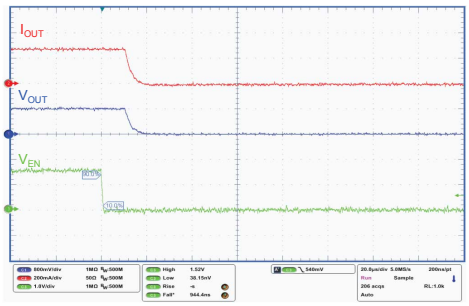


Figure 39. Turn-on time

V_{IN} = V_{EN} = 0 V to 5.5 V, I_{OUT} = 300 mA, V_{OUT} = 0.8 V, T_f = 5 µs

Figure 40. Turn-off time

V_{IN} = V_{EN} = 5.5 V to 0 V , I_{OUT} = 300 mA, V_{OUT} = 0.8 V, T_f = 5 µs

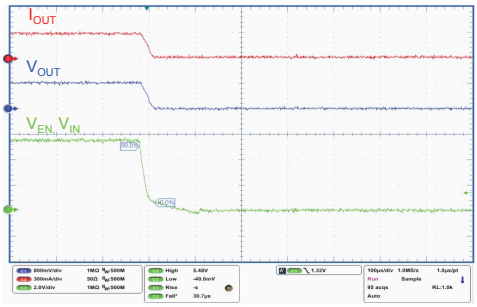


Figure 41. Line transient (auto green mode)

$V_{IN} = V_{EN}$ = 1.8 V to 2.3 V , I_{OUT} = 1 mA, V_{OUT} = 0.8 V, T_f = 5 µs (green mode)

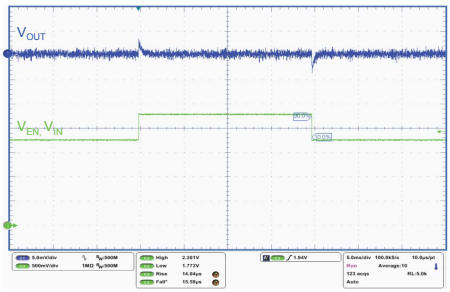


Figure 42. Line transient (normal mode)

$V_{IN} = V_{EN}$ = 1.8 V to 2.3 V , I_{OUT} = 12 mA, V_{OUT} = 0.8 V, T_f = 5 µs (normal mode)

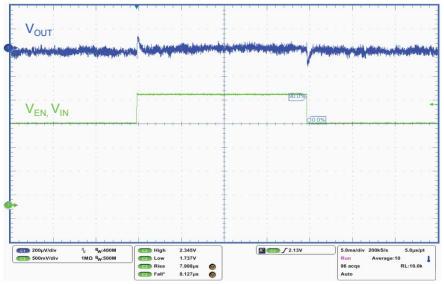


Figure 43. Load transient (I_{OUT} = 1 to 30 mA, auto green mode)

I_{OUT} = from 1 to 30 mA, V_{OUT} = 0.8 V, $T_r = T_f$ = 0.5 µs (auto green mode)

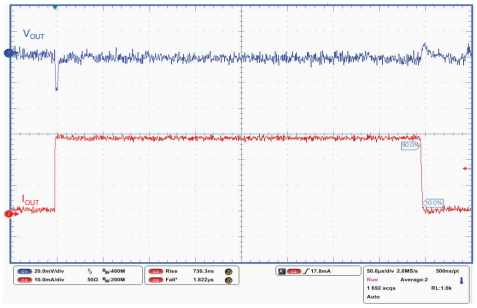


Figure 44. Load transient (I_{OUT} = 0 to 300 mA, auto green mode)

I_{OUT} = from 0 to 300 mA, V_{OUT} = 0.8 V, $T_r = T_f$ = 0.5 µs (auto green mode)

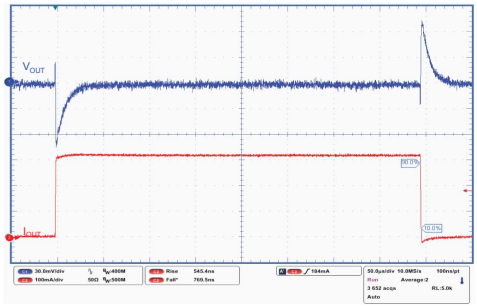


Figure 45. Load transient (I_{OUT} = 1 to 300 mA, normal mode)

I_{OUT} = from 1 to 300 mA, V_{OUT} = 0.8 V, $T_r = T_f$ = 5 µs, $V_{GM} = V_{in}$ (normal mode)

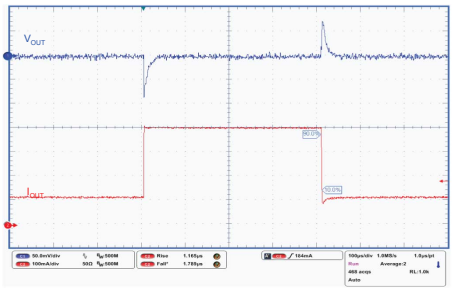
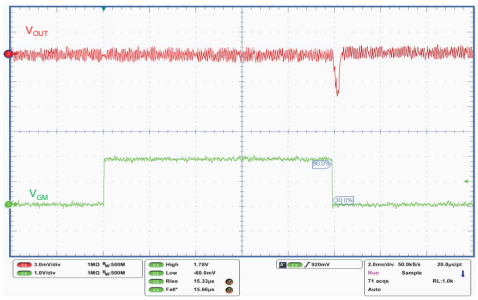


Figure 46. Green mode transient

I_{OUT} = 0 mA, V_{OUT} = 0.8 V, $T_r = T_f$ = 1 µs, V_{GM} = from 0 V to V_{in}

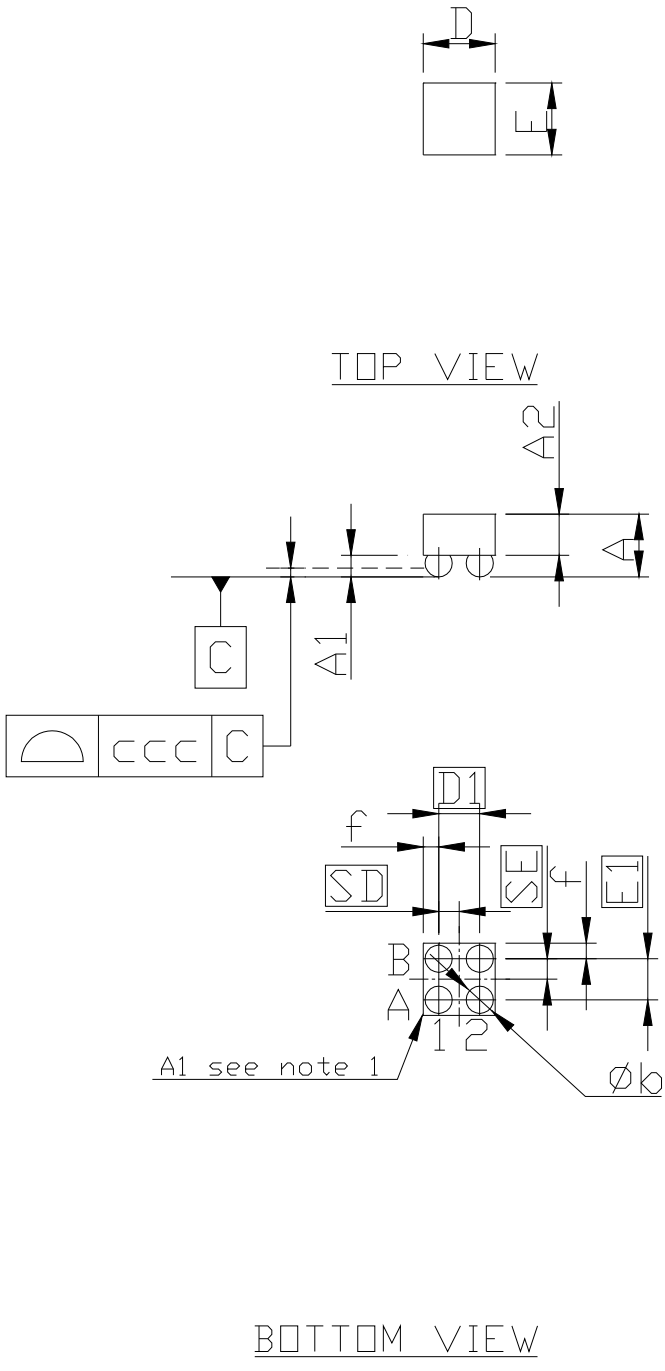


8 Package information

To meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com. ECOPACK is an ST trademark.

8.1 Flip-chip 4 package information

Figure 47. **Flip-chip 4 package mechanical outline**

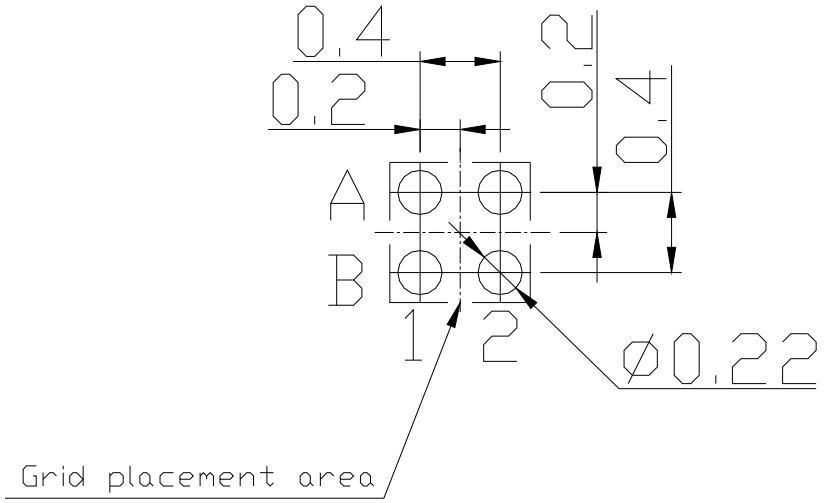


8288567 rev 5

Table 7. **Flip-chip 4 mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	0.445	0.48	0.515
A1	0.065	0.08	0.095
A2	0.38	0.40	0.42
b	0.12	0.16	0.2
D	0.66	0.69	0.72
D1		0.40	
E	0.66	0.69	0.72
E1		0.40	
f	0.135	0.145	0.155
SD/SE		0.20	
ccc			0.02

Figure 48. **Flip-chip 4 package footprint**



8288567 rev 5

8.2 DFN6 1.2x1.3 mm package information

Figure 49. **DFN6 1.2x1.3 mm package mechanical outline**

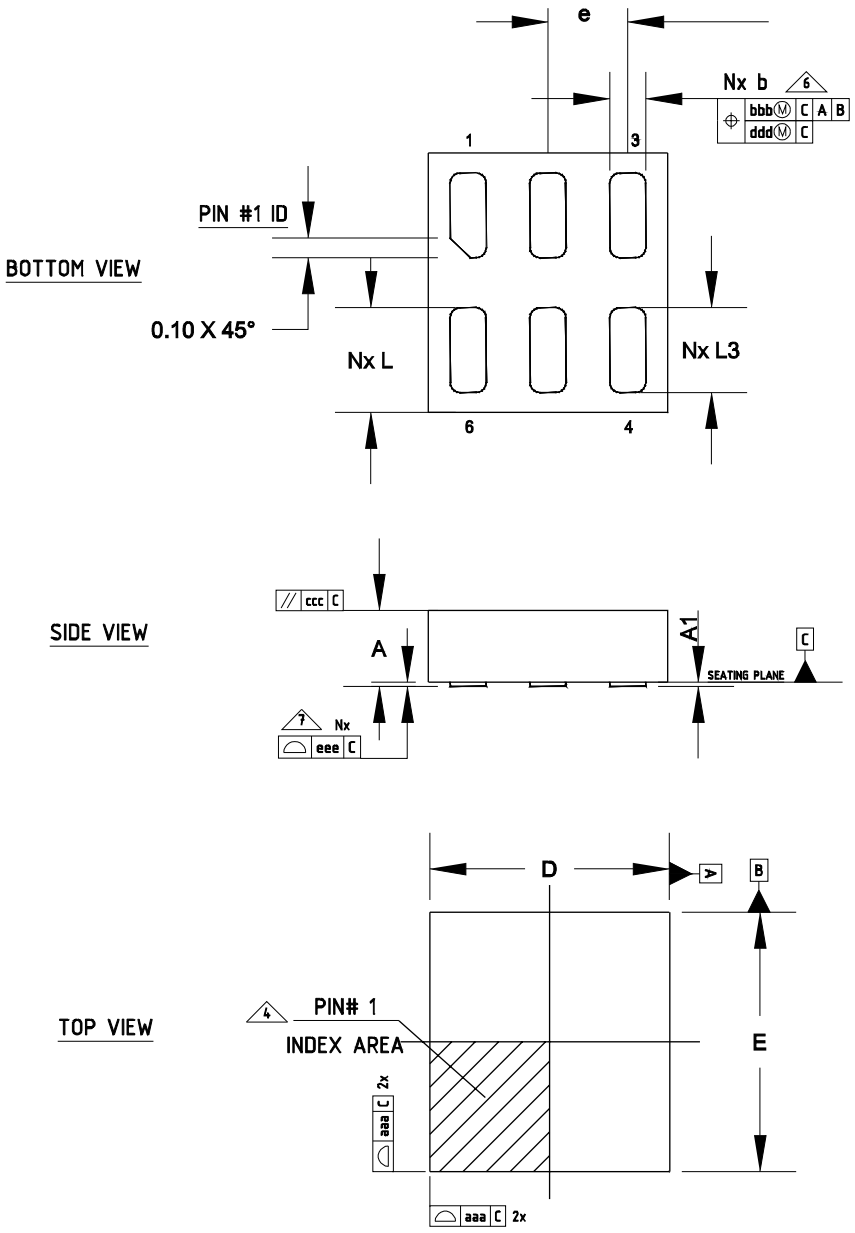


Table 8. DFN6 1.2x1.3 mm mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.31	0.38	0.40
A1	0.00	0.02	0.05
b	0.15	0.18	0.25
D	1.10	1.20	1.30
E	1.20	1.30	1.40
e		0.40 BSC	
L	0.475	0.525	0.575
L3	0.375	0.425	0.475
N		6	
ND		3	

Table 9. DFN6 1.2x1.3 mm tolerance of form and position

Dim.	mm
aaa	0.05
bbb	0.10
ccc	0.05
ddd	0.05
eee	0.05

Note: *1 - Dimensioning and tolerancing conform to ASME Y14.5-2009.*

2 - All dimension are in millimetres, angle are in degrees.

3 - N is the total numbers of terminals.

4 - The location of the marked terminal #1 identifier as within the hatched area.

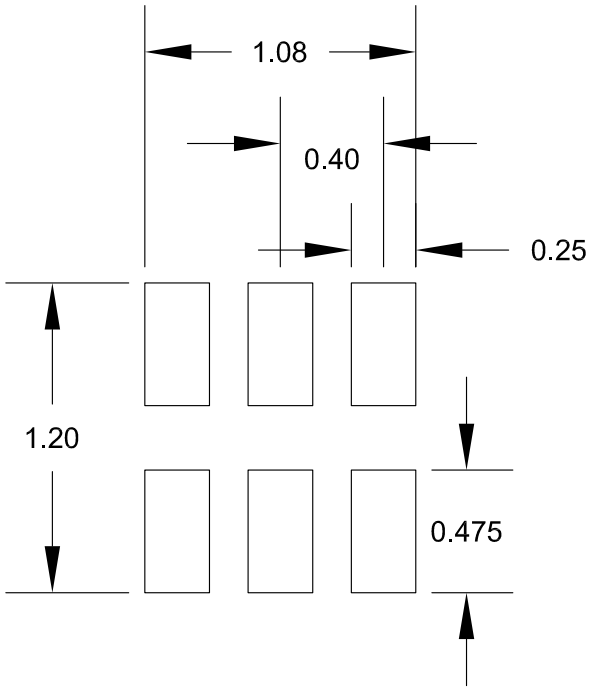
5 - ND refers to the maximum number of terminals D side.

6 - dimension b applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip. If the terminal has a radius on the other end, the dimension b should not be measured in that radius area.

7 - Coplanarity applies to the terminals and all other bottom surface metallization.

8 - Lead frame thickness is 0.127 mm

Figure 50. **DFN6 1.2x1.3 mm package footprint**



9 Packing information

Figure 51. **Flip-chip 4 tape**

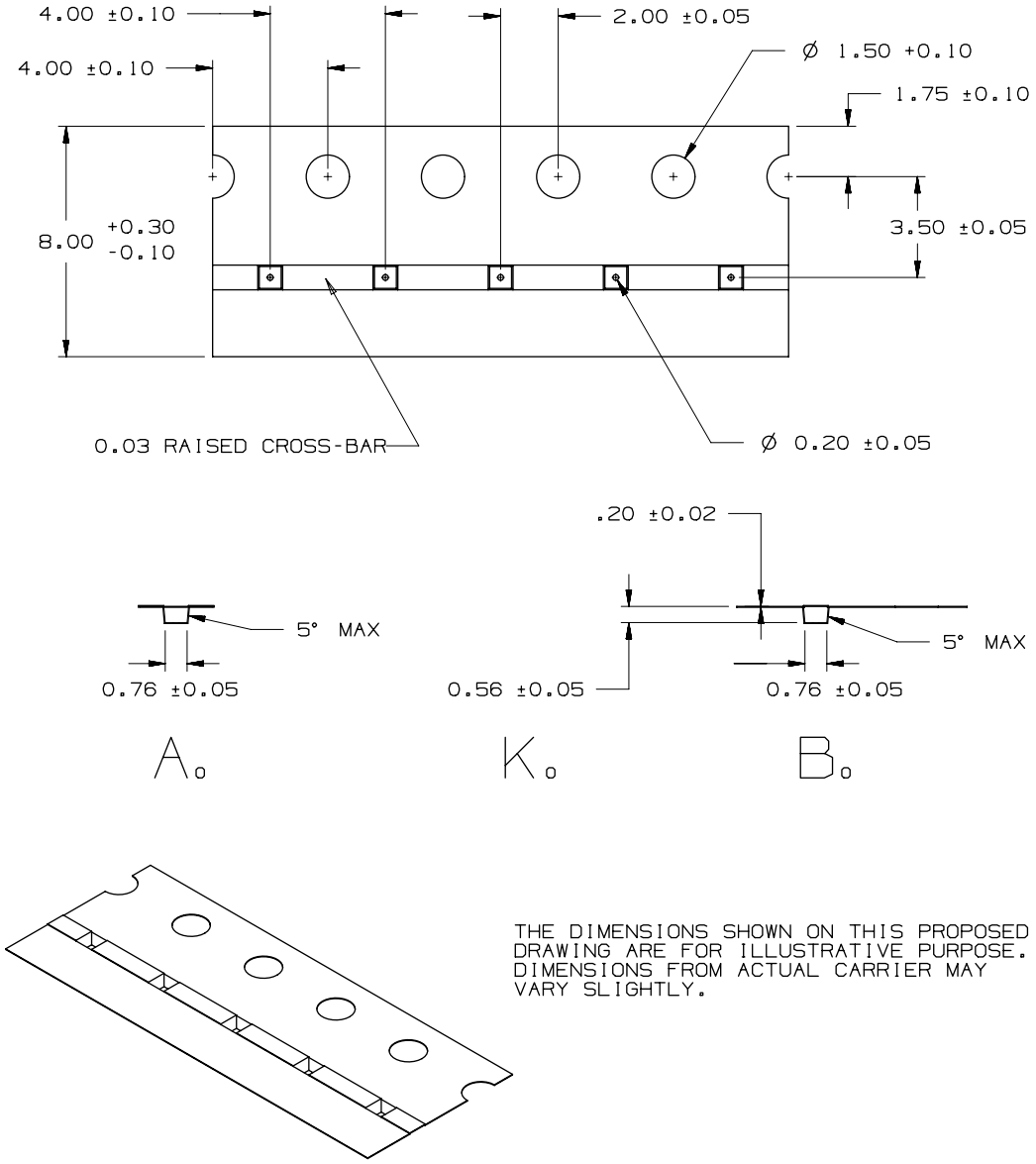


Figure 52. **Flip-chip 4 tape for LD39130SJ30R**

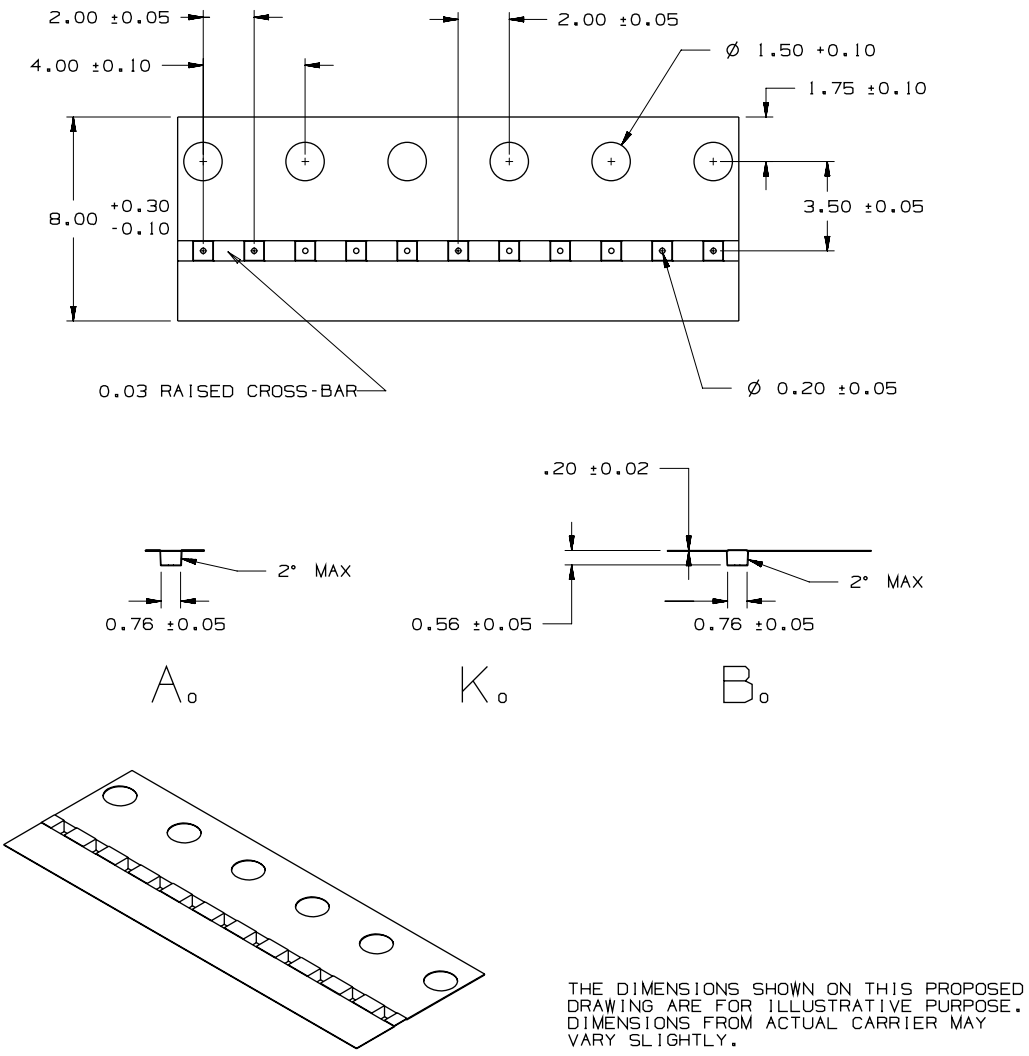


Figure 53. **Flip-chip 4 reel oriented**

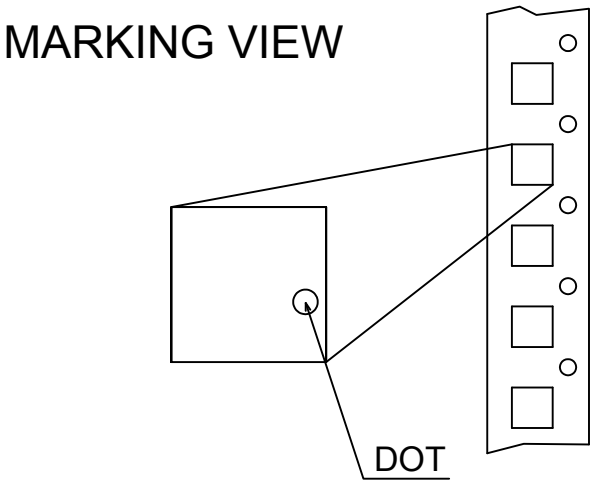
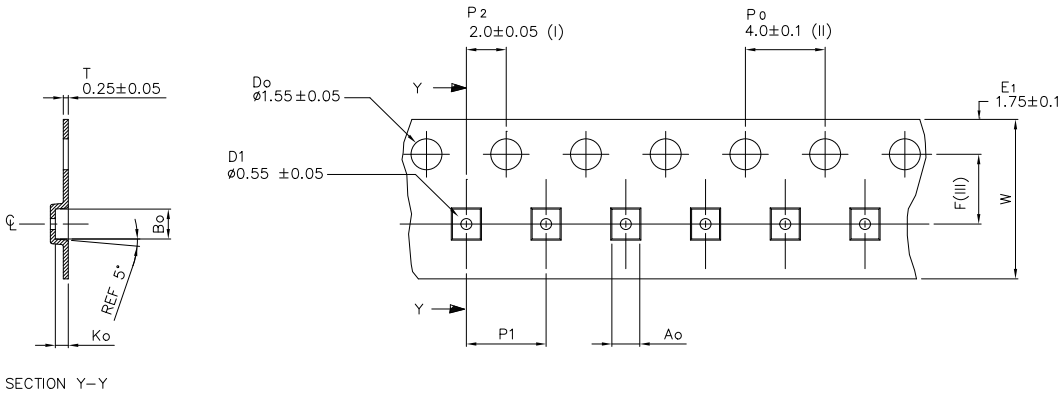


Figure 54. **DFN6 tape**



Ao	1.40 +/−0.05
Bo	1.50 +/−0.05
Ko	0.65 +/−0.05
F	3.50 +/−0.05
P1	4.00 +/−0.10
W	8.00 +/−0.30

(I) Measured from centreline of sprocket hole to centreline of pocket.
(II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
(III) Measured from centreline of sprocket hole to centreline of pocket.
(IV) Other material available.

ALL DIMENSIONS IN MILLIMETRES UNLESS OTHERWISE STATED.

Figure 55. **DFN6 reel oriented**

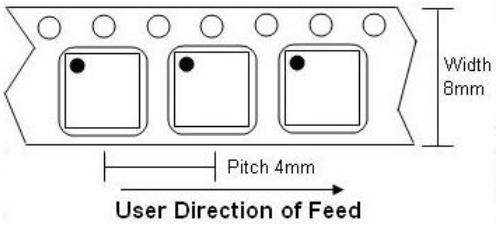
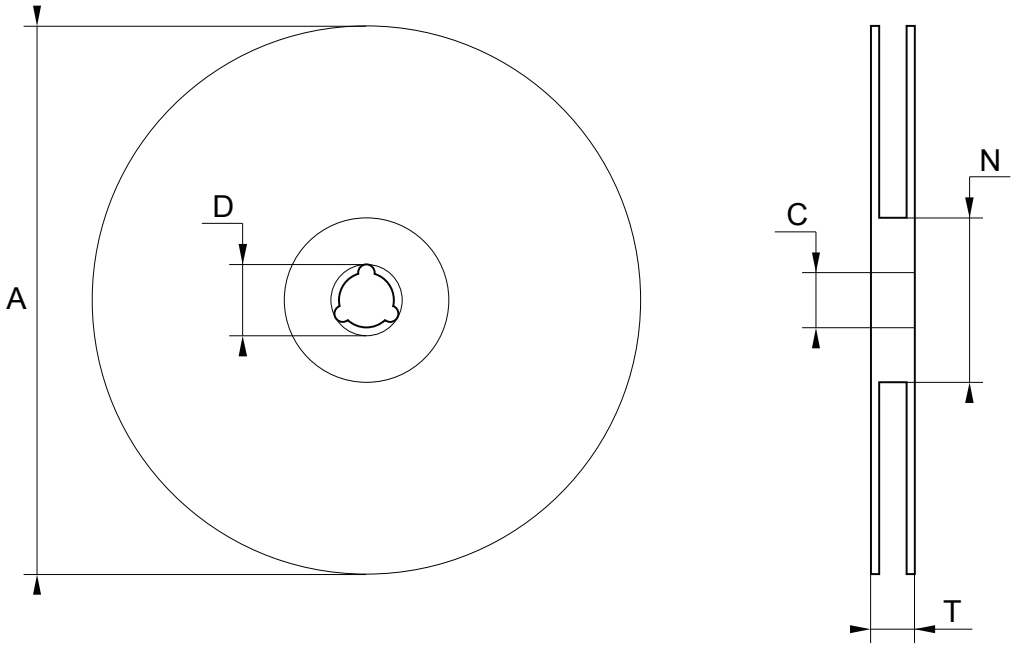


Table 10. **Reel mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A			180
C	12.8	13	13.2
D	20.2		
N	60		
T			14.4

Figure 56. **Reel outline**



Note: Drawing not in scale

10 Order codes

Table 11. **Order codes**

Order codes		Output voltages (V)	Marking digits (XY)
DFN6 1.2x1.3 mm	Flip-chip 4		
LD39130SPUR		Adjustable	AD
	LD39130SJ10R(1)	1.0	10
	LD39130SJ12R(1)	1.2	12
	LD39130SJ18R(1)	1.8	18
LD39130SPU25R	LD39130SJ25R(1)	2.5	25
	LD39130SJ28R (1)	2.8	28
	LD39130SJ29R(1)	2.9	29
	LD39130SJ30R(2)	3.0	30
LD39130SPU31R		3.1	31
	LD39130SJ33R(1)	3.3	33
	LD39130SJ41R(1)	4.1	41

1. *Packed in 4 mm cavity pitch, with 5 k pcs bulk.*
2. *Packed in 2 mm cavity pitch, with 10 k pcs bulk.*

Note: Other output voltage versions available on request.

Figure 57. **Flip-chip and DFN6 1.2x1.3 marking composition (marking view)**

Note: "xy" indicates the marking digits, as per Table 11. Table 9. Order codes.

Revision history

Table 12. **Document revision history**

Date	Revision	Changes
08-Oct-2013	1	Initial release.
20-Jan-2015	2	Updated Figure 19: Quiescent current vs. input voltage (auto green mode) and Figure 23: Quiescent current vs. load current (light load) Updated Table 3: Thermal data, Table 4: ESD performance, Table 5: LD39130S/LD39130SJ electrical characteristics (fixed versions), Table 6: LD39130S electrical characteristics (adjustable version), Figure 19: Quiescent current vs. input voltage (auto green mode), Figure 23: Quiescent current vs. load current (light load), Figure 39: Turn-on time and Figure 41: Line transient (auto green mode). Minor text changes.
04-Apr-2018	3	Throughout document: - minor text and formatting changes In Table 1. Pin description: - updated GM and EN function descriptions Updated Figure 5. Typical application circuits Added Section 6.1 Output voltage setting for ADJ version Updated Section 7 Typical characteristics Updated Table 9. Order codes
13-Jun-2018	4	Updated Figure 50. DFN6 1.2x1.3 mm package mechanical outline.
06-Jul-2018	5	Updated Table 8. DFN6 1.2x1.3 mm mechanical data.
11-May-2020	6	Added new Figure 52 and footnote in Table 10.
06-Nov-2020	7	Updated Section 8.2: DFN6 1.2x1.3 mm package information.
26-Aug-2024	8	Updated Section 10

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